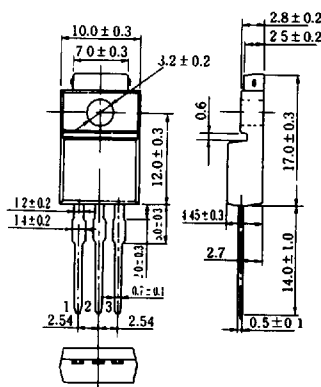
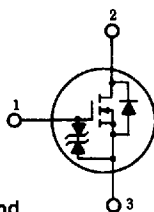


SILICON N-CHANNEL MOS FET HIGH SPEED POWER SWITCHING

FEATURES

- Low On-Resistance
- High Speed Switching
- Low Drive Current
- No Secondary Breakdown
- Suitable for Switching Regulator and DC-DC Converter



1. Gate
2. Drain
3. Source
(Dimensions in mm)

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$)

(JEDEC TO-220FM)

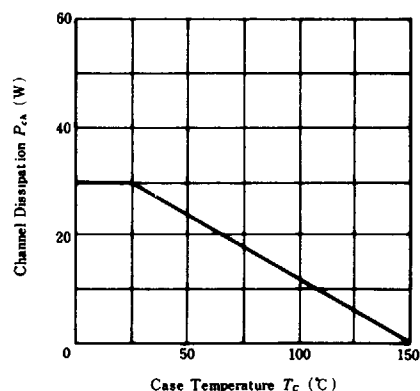
Item	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	900	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current	I_D	2	A
Drain Peak Current	$I_{D(pulse)}$	6	A
Body-Drain Diode Reverse Drain Current	I_{DR}	2	A
Channel Dissipation	P_{ch}	30	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	$-55 \sim +150$	$^\circ\text{C}$

* $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$

** Value at $T_c=25^\circ\text{C}$

POWER VS.

TEMPERATURE DERATING

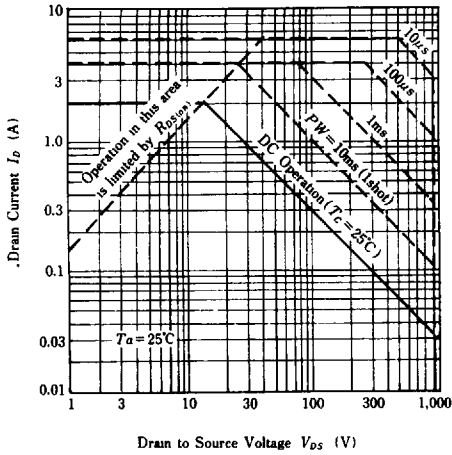


ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$)

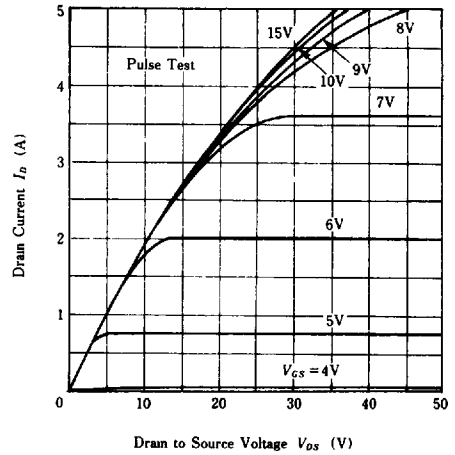
Item	Symbol	Test Condition	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DS}$	$I_D=10\text{mA}$, $V_{GS}=0$	900	—	—	V
Gate-Source Breakdown Voltage	$V_{(BR)GS}$	$I_G=\pm 100 \mu\text{A}$, $V_{DS}=0$	± 20	—	—	V
Gate-Source Leak Current	I_{GSS}	$V_{GS}=\pm 16\text{V}$, $V_{DS}=0$	—	—	± 10	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=720\text{V}$, $V_{GS}=0$	—	—	250	μA
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$I_D=1\text{mA}$, $V_{DS}=10\text{V}$	2.0	—	4.0	V
Static Drain-Source on State Resistance	$R_{DS(on)}$	$I_D=1\text{A}$, $V_{GS}=10\text{V}$ *	—	5.0	7.0	Ω
Forward Transfer Admittance	$ y_{fs} $	$I_D=1\text{A}$, $V_{DS}=20\text{V}$ *	0.6	1.0	—	S
Input Capacitance	C_{iss}	$V_{DS}=10\text{V}$, $V_{GS}=0$ $f=1\text{MHz}$	—	490	—	pF
Output Capacitance	C_{oss}		—	260	—	pF
Reverse Transfer Capacitance	C_{rss}		—	190	—	pF
Turn-On Delay Time	$t_{d(on)}$	$I_D=1\text{A}$, $V_{GS}=10\text{V}$ $R_L=30\Omega$	—	10	—	ns
Rise Time	t_r		—	60	—	ns
Turn-off Delay Time	$t_{d(off)}$		—	65	—	ns
Fall Time	t_f		—	60	—	ns
Body-Drain Diode Forward Voltage	V_{DF}	$I_F=2\text{A}$, $V_{GS}=0$	—	0.9	—	V
Body-Drain Diode Reverse Recovery Time	t_{rr}	$I_F=2\text{A}$, $V_{GS}=0$ $di_F/dt=100\text{A}/\mu\text{s}$	—	800	—	ns

*Pulse Test

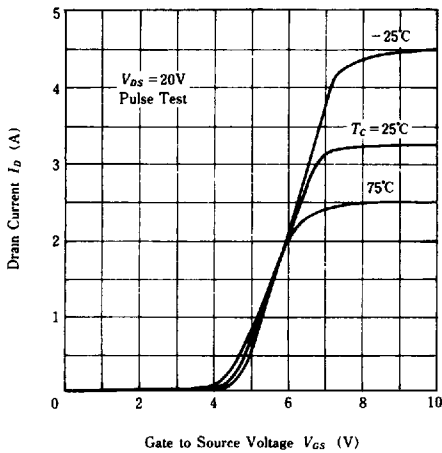
MAXIMUM SAFE OPERATION AREA



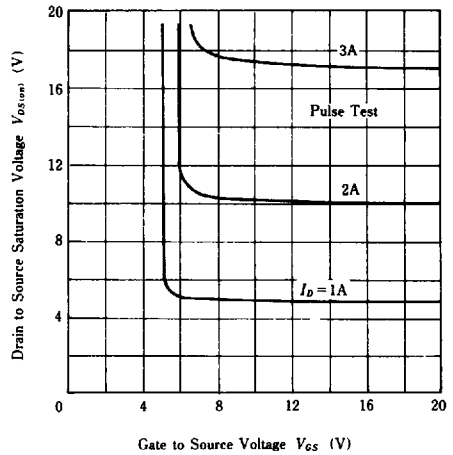
TYPICAL OUTPUT CHARACTERISTICS



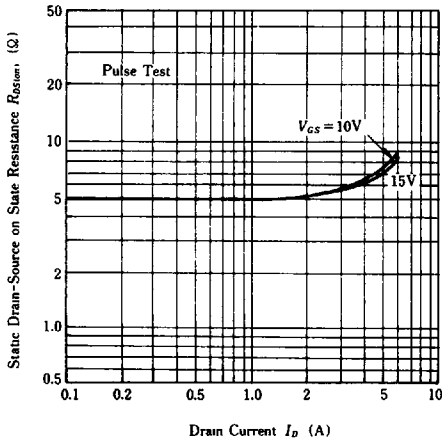
TYPICAL TRANSFER CHARACTERISTICS



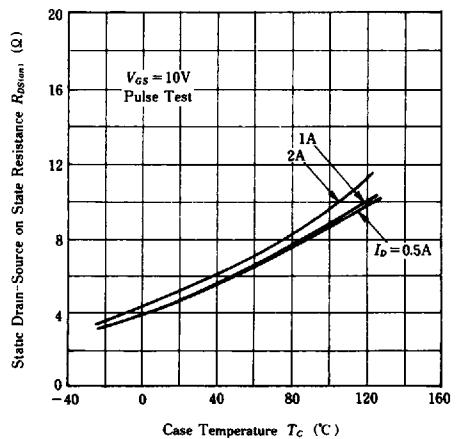
DRAIN-SOURCE SATURATION VOLTAGE VS. GATE-SOURCE VOLTAGE



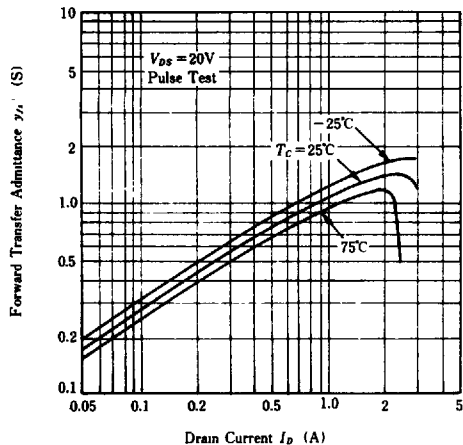
STATIC DRAIN-SOURCE ON STATE RESISTANCE VS. DRAIN CURRENT



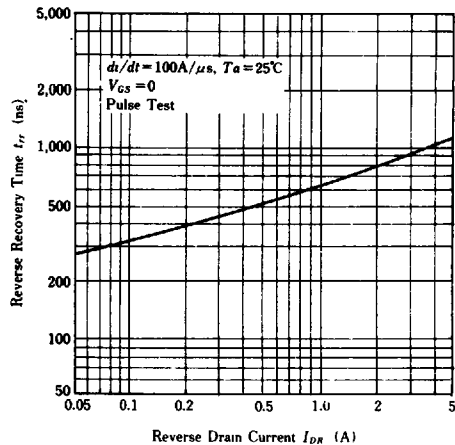
STATIC DRAIN-SOURCE ON STATE RESISTANCE VS. TEMPERATURE



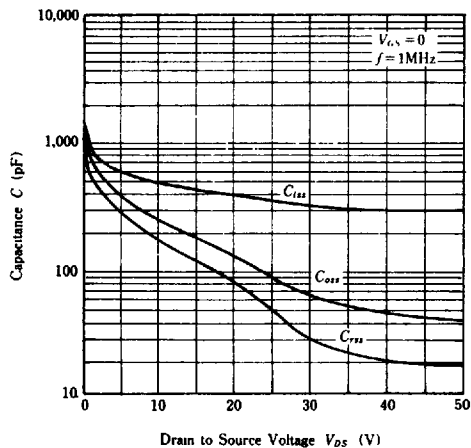
**FORWARD TRANSFER ADMITTANCE
VS. DRAIN CURRENT**



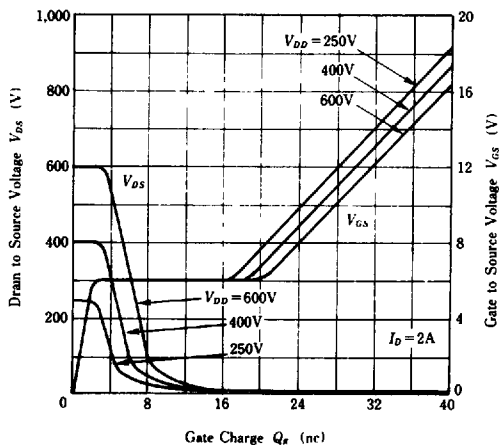
**BODY-DRAIN DIODE REVERSE
RECOVERY TIME**



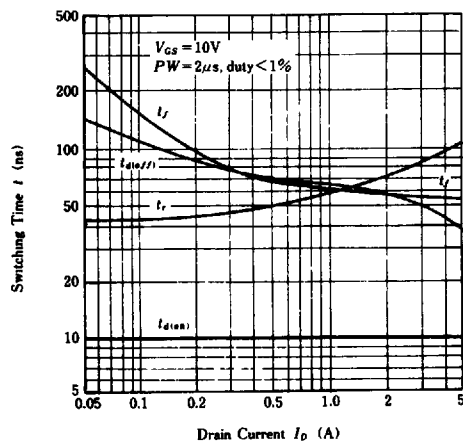
**TYPICAL CAPACITANCE
VS. DRAIN-SOURCE VOLTAGE**



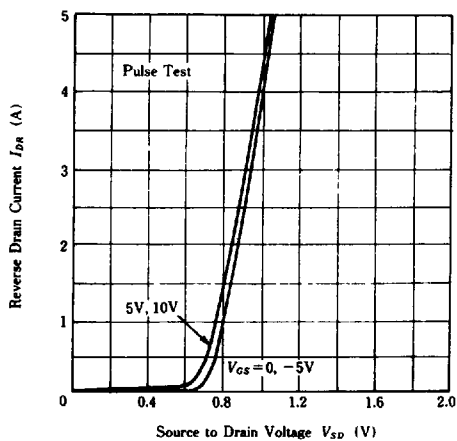
DYNAMIC INPUT CHARACTERISTICS



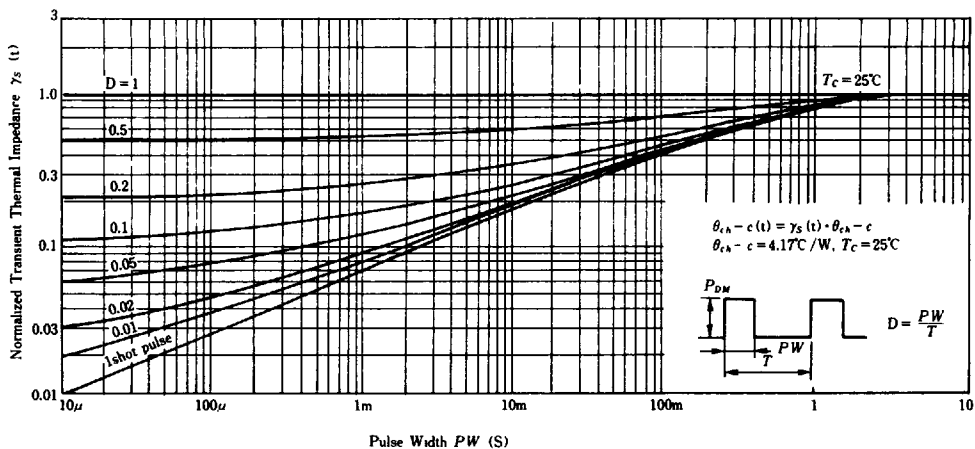
SWITCHING CHARACTERISTICS



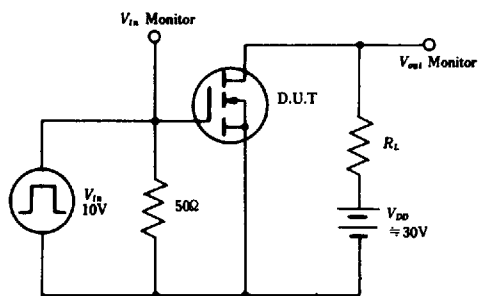
**REVERSE DRAIN CURRENT VS.
SOURCE TO DRAIN VOLTAGE**



NORMALIZED TRANSIENT THERMAL IMPEDANCE VS. PULSE WIDTH



SWITCHING TIME TEST CIRCUIT



WAVEFORMS

